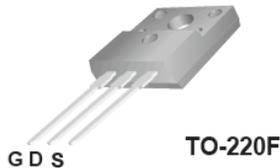


# TSF65R950S1

## 650V 4.5A N-Channel SJ-MOSFET

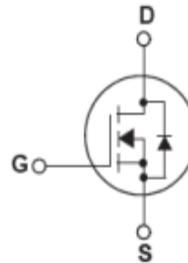
### General Description

Truesemi SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme  $dv/dt$  rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.



### Features

- 700V @  $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 0.85\Omega$
- Ultra Low gate charge (typ.  $Q_g = 15\text{nC}$ )
- 100% avalanche tested



### Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	650	V
$I_D$	Drain Current -Continuous ( $TC = 25^\circ\text{C}$ )	4.5*	A
	-Continuous ( $TC = 100^\circ\text{C}$ )	2.9*	
$I_{DM}$	Drain Current – Pulsed (Note 1)	12*	A
$V_{GSS}$	Gate-Source voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	46	mJ
$I_{AR}$	Avalanche Current (Note 1)	1	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	0.2	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)	15	V/ns
$P_D$	Power Dissipation ( $TC = 25^\circ\text{C}$ )	26	W
	-Derate above $25^\circ\text{C}$	0.3	
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

\* Drain current limited by maximum junction temperature.

### Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	4.9	$^\circ\text{C/W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	--	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	80	$^\circ\text{C/W}$

## Electrical Characteristics TC = 25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Off Characteristics						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^\circ C$	650	--	--	V
		$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^\circ C$	--	700	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$ , Referenced to 25 °C	--	0.6	--	V/°C
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V, -T_J = 125^\circ C$	--	-- 10	1 --	$\mu A$ $\mu A$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30V, V_{DS} = 0V$	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	3.5	4.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 2.5A$	--	0.85	0.95	$\Omega$
$g_{FS}$	Forward Trans conductance	$V_{DS} = 40V, I_D = 2.5A$ (Note 4)	--	8	--	S
$R_g$	Gate resistance	f=1MHz, open drain	--	3.5	--	$\Omega$
Dynamic Characteristics						
$C_{iss}$	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	--	320	--	pF
$C_{oss}$	Output Capacitance		--	75	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	5	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 400V, I_D = 2.5A, R_G = 20\Omega$ (Note 4, 5)	--	10	--	ns
$t_r$	Turn-On Rise Time		--	8	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	60	--	ns
$t_f$	Turn-Off Fall Time		--	13	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480V, I_D = 2.5A, V_{GS} = 10V$ (Note 4, 5)	--	15	--	nC
$Q_{gs}$	Gate-Source Charge		--	3	--	nC
$Q_{gd}$	Gate-Drain Charge		--	6	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current		--	--	4.5	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current		--	--	16	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_F = 2.5A$	--	0.9	1.5	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0V, I_F = 2.5A, di_F/dt = 100A/\mu s$ (Note 4)	--	180	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	1.5	--	$\mu C$

## NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{AS}=1A, V_{DD}=50V$ , Starting  $T_J=25^\circ C$
3.  $I_{SD}\leq 4.5A, di/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ C$
4. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics

# Typical Performance Characteristics

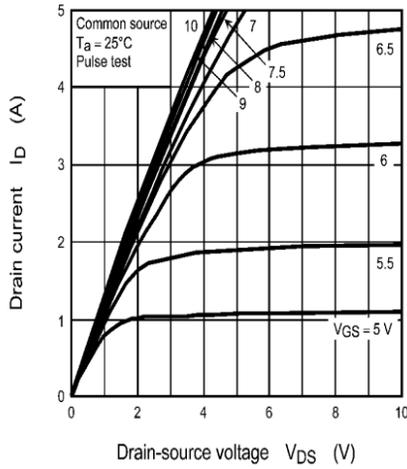


Figure 1: On-Region Characteristics@25°C

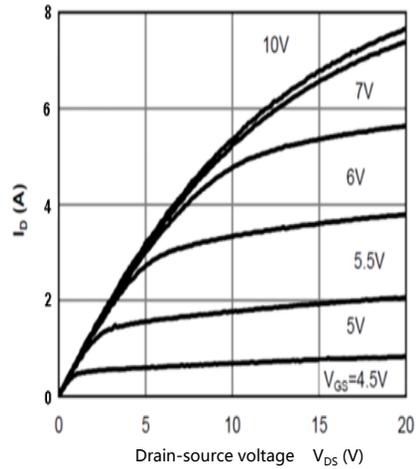


Figure 2: On-Region Characteristics@125°C

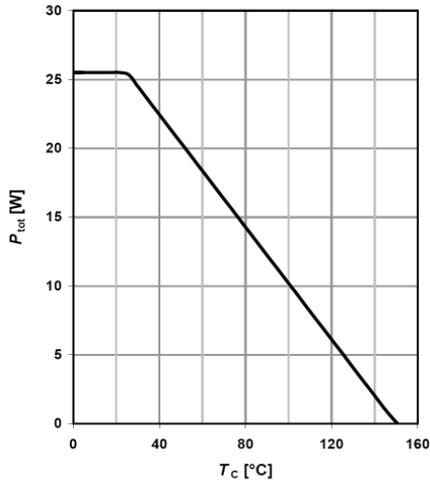


Figure 3: Power Dissipation

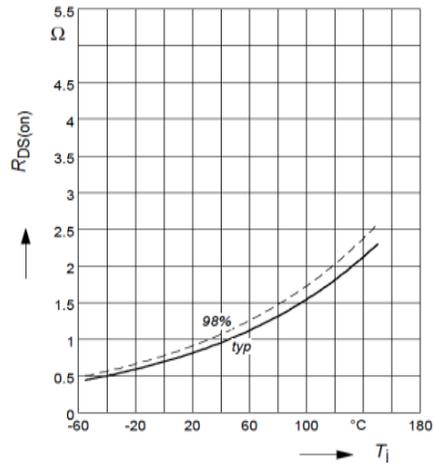


Figure 4: On-Resistance vs. Junction Temperature

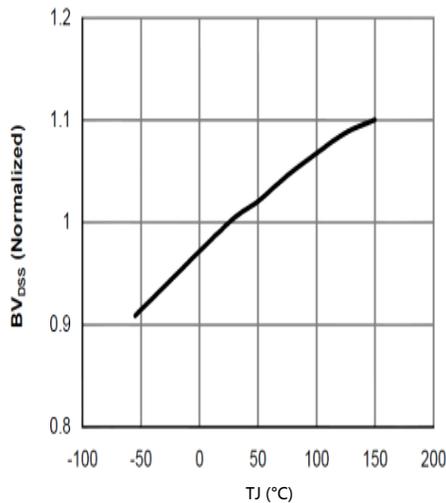


Figure 5: Break Down vs. Junction Temperature

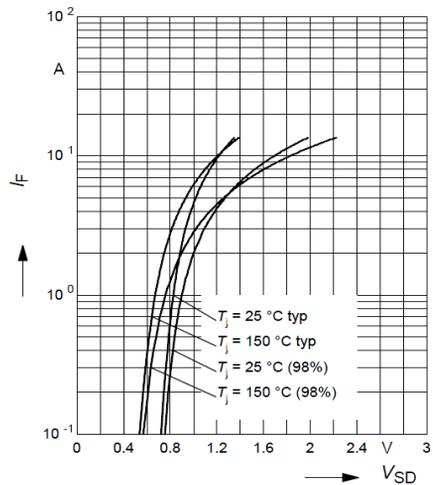


Figure 6: Body-Diode Characteristics

# Typical Performance Characteristics

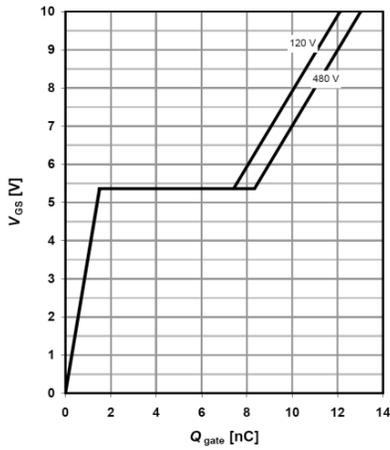


Figure 7: Gate-Charge Characteristics

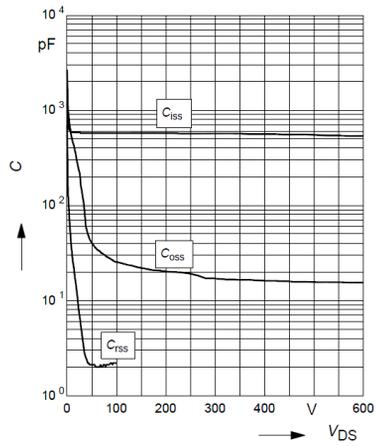


Figure 8: Capacitance Characteristics

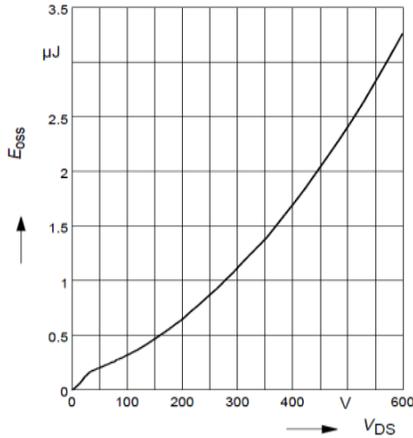


Figure 9:  $C_{oss}$  stored Energy

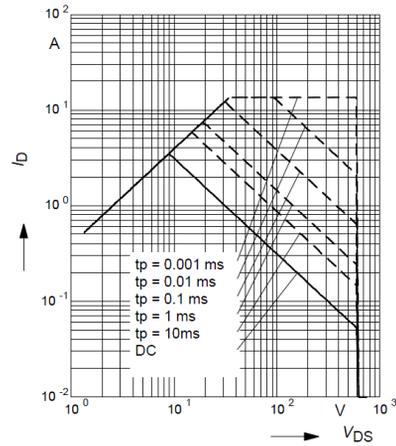


Figure 10: Maximum Forward Biased Safe Operating Area  $T_c=25^\circ\text{C}$ ,

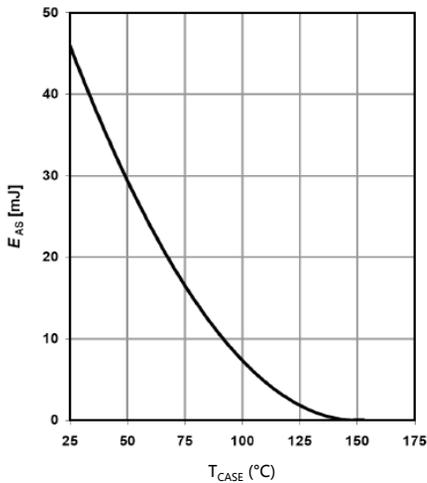


Figure 11: Avalanche energy

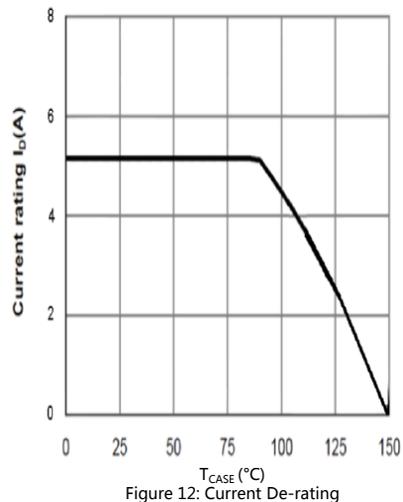


Figure 12: Current De-rating

# Typical Performance Characteristics

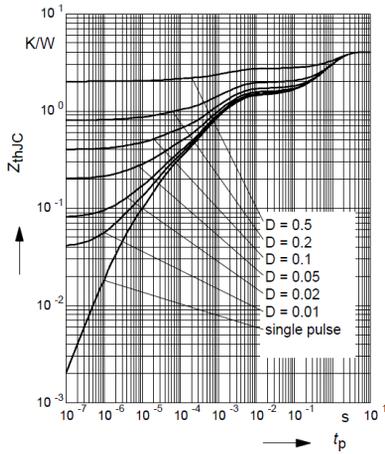


Figure 13: Single Pulse Power Rating Junction-to-Case

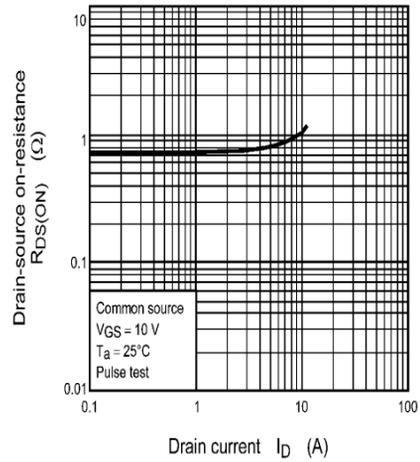


Figure 14 On-Resistance vs. Drain Current and Gate Voltage

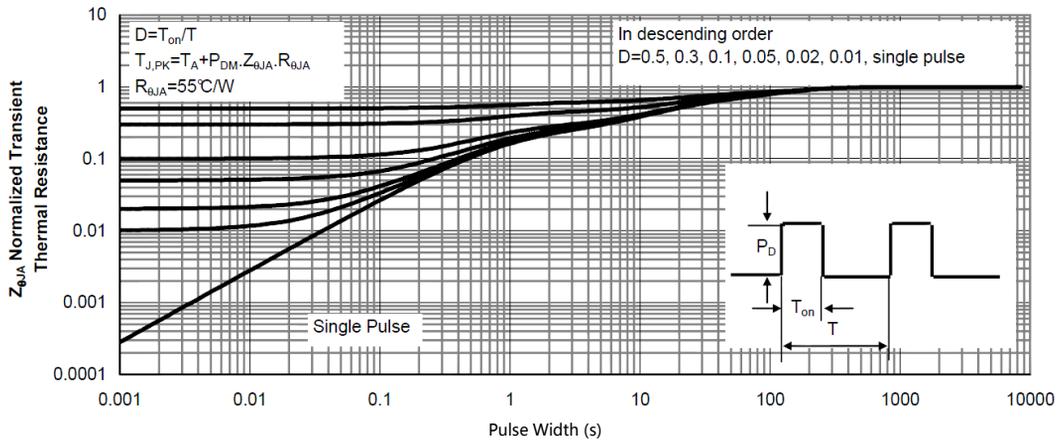


Figure 15: Normalized Maximum Transient Thermal Impedance

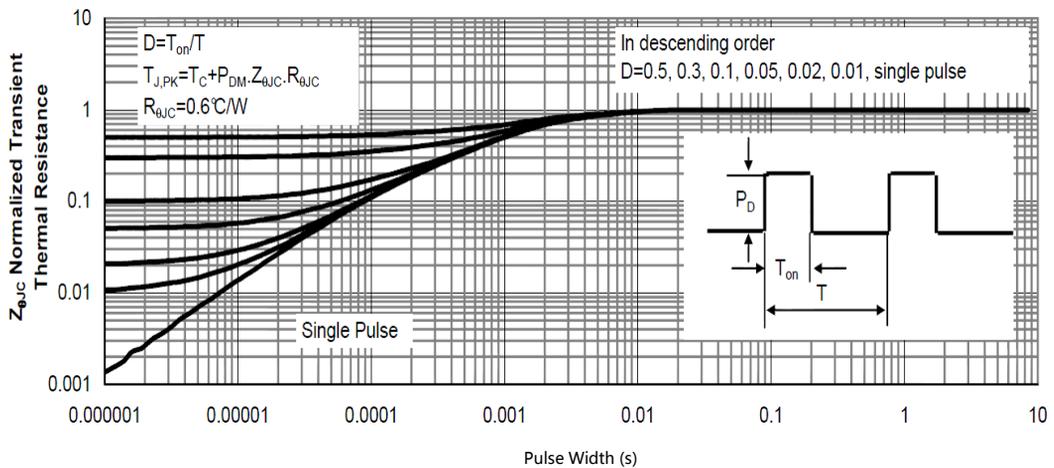
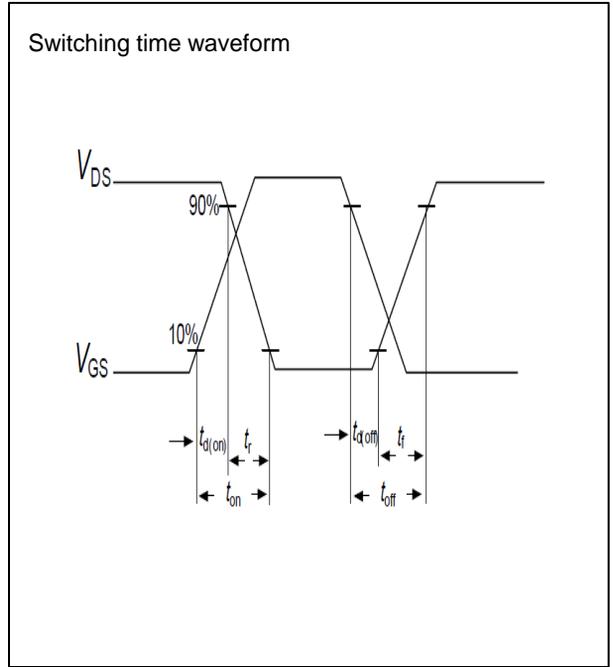
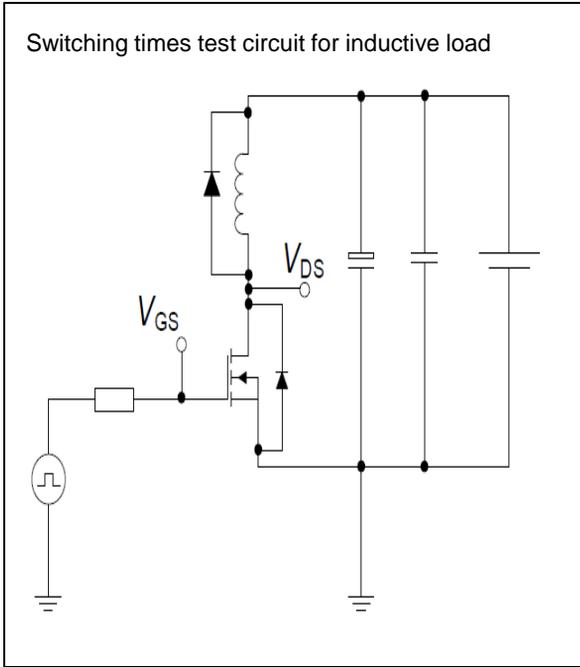


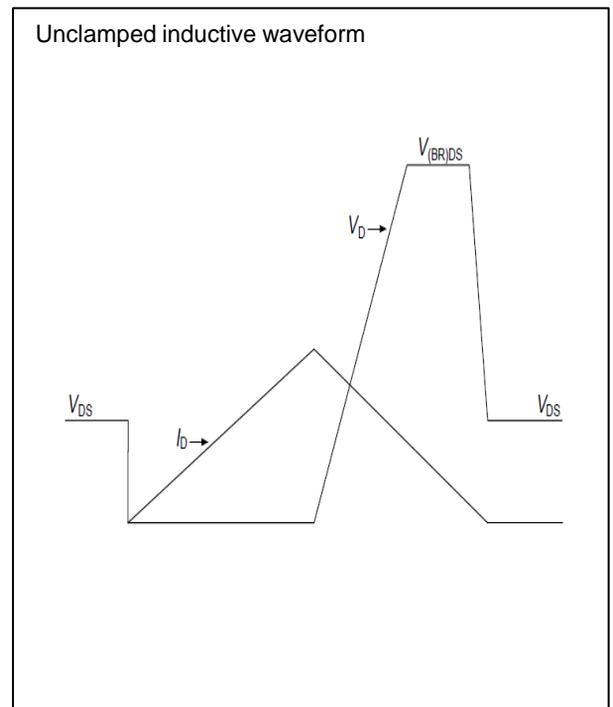
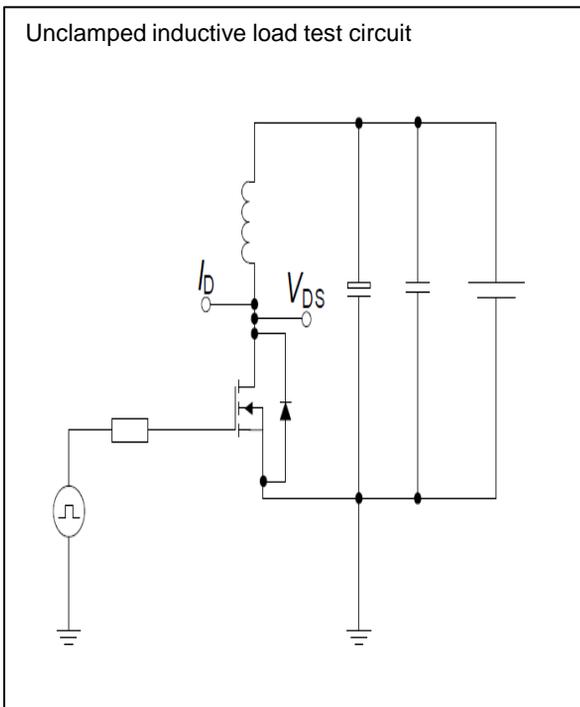
Figure 16: Normalized Maximum Transient Thermal Impedance

# Test circuits

## Switching times test circuit and waveform for inductive load

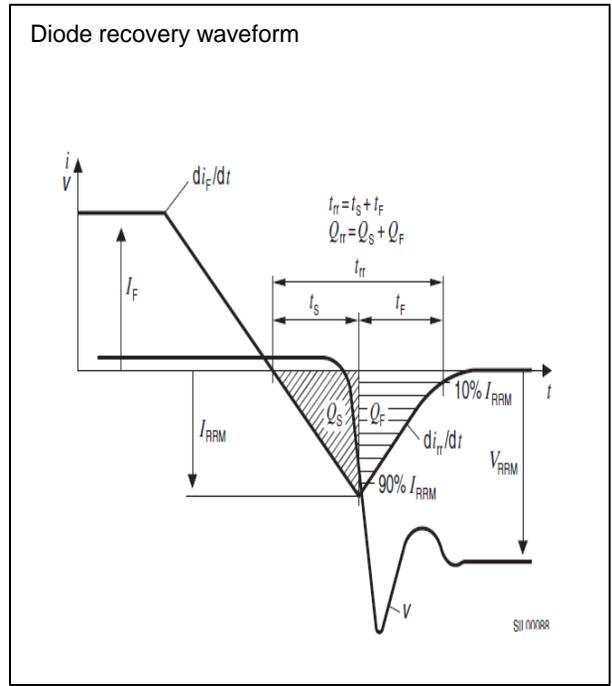
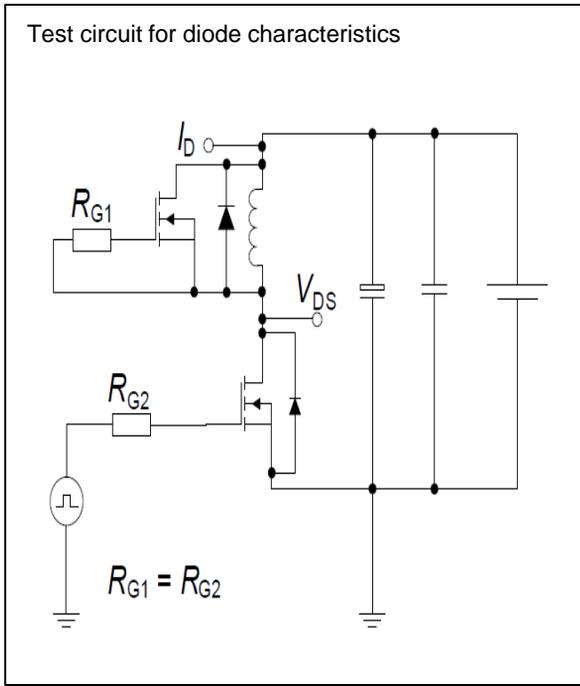


## Unclamped inductive load test circuit and waveform

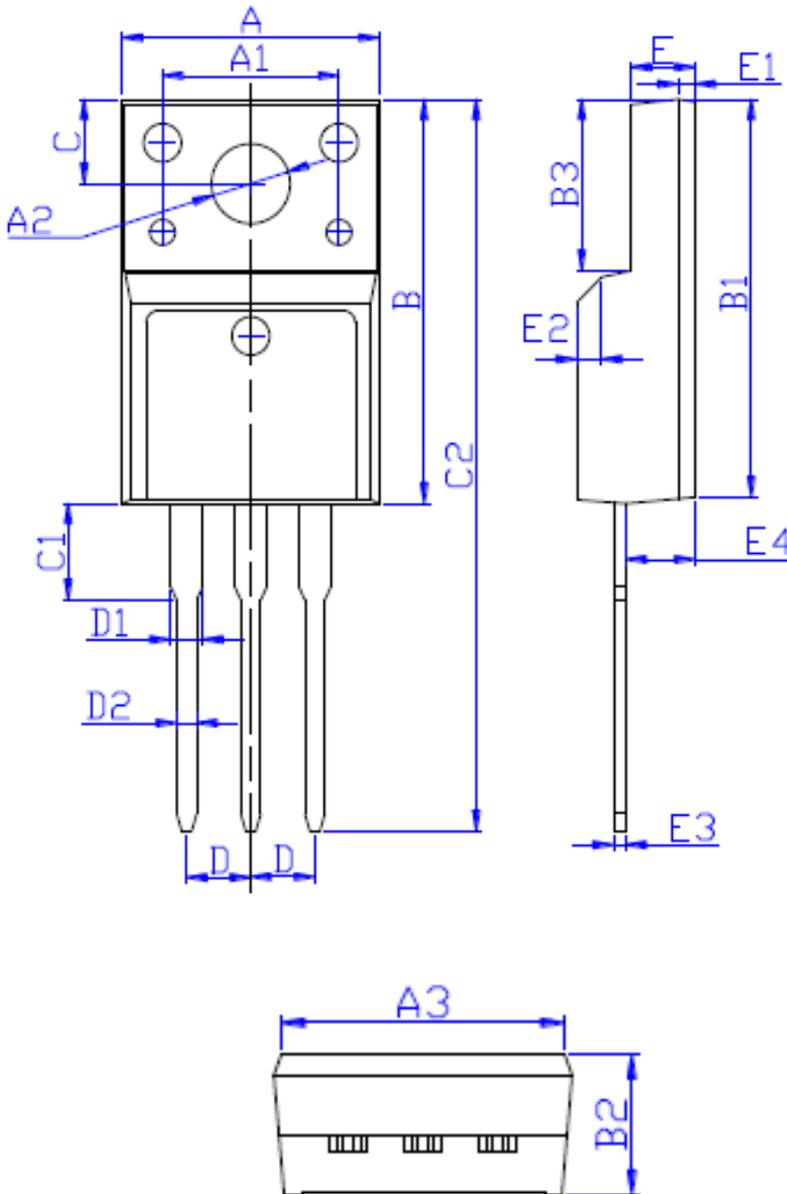


# Test circuits

## Test circuit and waveform for diode characteristics



# Package Outline TO-220F



DIM	MILLIMETERS
A	10.16 ± 0.30
A1	7.00 ± 0.20
A2	3.12 ± 0.20
A3	9.70 ± 0.30
B	15.90 ± 0.50
B1	15.60 ± 0.50
B2	4.70 ± 0.30
B3	6.70 ± 0.30
C	3.30 ± 0.25
C1	3.25 ± 0.30
C2	28.70 ± 0.50
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80 ± 0.20
E	2.55 ± 0.25
E1	0.70 ± 0.25
E2	1.0 × 45°
E3	0.50 ± 0.20
E4	2.75 ± 0.30